

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

ETAS ID: TM660611

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
Silicon Valley Bank		07/08/2021	Corporation:
RECEIVING PARTY DATA			
Name:	NANTERO, INC.		
Street Address:	25 OLYMPIA AVENUE SUITE B		
City:	WOBURN		
State/Country:	MASSACHUSETTS		
Postal Code:	01801		
Entity Type:	Corporation: DELAWARE		
PROPERTY NUMBERS Total: 6			
Property Type	Number	Word Mark	
Registration Number:	3720099	ENRAM	
Registration Number:	3723784	NANOLOGIC	
Registration Number:	3127237	NANTERO	
Registration Number:	4151679	NRAM	
Registration Number:	5377792	NTDF	
Registration Number:	5377794	NTSL	
CORRESPONDENCE DATA			
Fax Number:			
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
Email:	patent-review@nantero.com		
Correspondent Name:	NANTERO, INC.		
Address Line 1:	25 OLYMPIA AVENUE SUITE B		
Address Line 4:	WOBURN, MASSACHUSETTS 01801		
NAME OF SUBMITTER:	Brett Squires		
SIGNATURE:	/Brett Squires/		
DATE SIGNED:	07/16/2021		
Total Attachments: 5			
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RELEASE OF SECURITY INTEREST IN TRADEMARKS

This Release of Security Interest in Trademarks (this "Release"), dated as of July 8, 2021 (the "Effective Date"), is executed by Silicon Valley Bank ("Bank"), in favor of Nantero, Inc., a Delaware corporation (the "Borrower").

RECITALS

WHEREAS, the Borrower and the Bank executed that certain Loan and Security Agreement dated as of May 10, 2018 (as the same may from time to time have been amended, restated, or otherwise modified, the "Loan Agreement");

WHEREAS, in connection with that certain Second Amendment to Loan and Security Agreement dated as of November 10, 2020, the Borrower and Bank entered into an Intellectual Property Security Agreement dated as of November 10, 2020 (the "IP Security Agreement"), pursuant to which the Borrower granted and pledged to the Bank a security interest in all of the Borrower's right, title and interest in, to and under its intellectual property;

WHEREAS, a copy of the IP Security Agreement was recorded in the United States Patent and Trademark Office, pursuant to which the parties thereto caused to be reflected as of record the Borrower's grant of a security interest in the registered trademarks (and applications therefor) of the United States identified on Schedule 1 attached hereto (collectively, the "Trademarks");

WHEREAS, pursuant to that certain Payoff Letter, dated as of June 18, 2021, between the Borrower and the Bank (the "Payoff Letter"), the Bank agreed to release its security interests in and liens on the Trademarks (and the other assets described therein) in accordance with the terms and conditions thereof, and has agreed to execute this Release to evidence of record such release.

RELEASE


NOW, THEREFORE, the Bank agrees as follows, effective as of the Effective Date:

1. The Bank is executing and delivering this Release as evidence of the release of security interests in the Trademarks as contemplated by the Payoff Letter.
2. The Bank hereby expressly releases its security interest in the Trademarks.

[Remainder of page intentionally left blank; signatures follow]

IN WITNESS WHEREOF, this Release has been executed as of the Effective Date.

SILICON VALLEY BANK

By: 
Name: Bellet Eliasnia
Title: Managing Director – Advisory Services

[Signature Page to Release of Security Interest in Patents]

SCHEDULE 1**TO****RELEASE OF GRANT OF SECURITY INTEREST
IN TRADEMARKS****SCHEDULE 1**

Mark	Country	Registration Date	Registration No.
ENRAM	China Madrid Protocol	04/10/2017	878496
ENRAM	European Community Madrid Protocol	04/13/2006	878496
ENRAM	Japan Madrid Protocol	01/25/2007	878496
ENRAM	International Registration designating: China European Community Japan	01/11/2006	878496
ENRAM	United Kingdom	04/13/2006	UK00800878496
ENRAM	United States	12/01/2009	3720099
NANOLOGIC	European Community Madrid Protocol	09/15/2005	858270
NANOLOGIC	International Registration designating: European Community	07/12/2005	858270
NANOLOGIC	United Kingdom	09/15/2005	UK00800858270
NANOLOGIC	United States	12/08/2009	3723784
NANTERO	Canada	11/01/2010	781288
NANTERO	European Community	04/22/2003	2538668
NANTERO	International Registration	12/14/2016	1335136
NANTERO	Japan	12/06/2002	4626495
NANTERO	Korea	11/18/2003	565776
NANTERO	Singapore	10/04/2001	T0200885B
NANTERO	Taiwan	09/16/2003	1057373
NANTERO	United Kingdom	04/22/2003	UK00902538668
NANTERO	United States	08/08/2006	3127237
NRAM	Canada	11/01/2010	781290
NRAM	European Community	08/14/2003	2538676
NRAM	China Madrid Protocol	03/30/2018	1330999

NRAM	Japan Madrid Protocol	05/25/2017	1330999
NRAM	International Registration designating: China Japan	12/14/2016	1330999
NRAM	Korea	11/18/2003	565777
NRAM	Singapore	10/04/2001	T0200886J
NRAM	Taiwan	03/16/2003	1036746
NRAM	United Kingdom	08/14/2003	UK00902538676
NRAM	United States	05/29/2012	4151679
NTDF	China Madrid Protocol	03/14/2018	1338246
NTDF	European Community Madrid Protocol	04/06/2017	1338246
NTDF	Japan Madrid Protocol	07/20/2017	1338246
NTDF	Korea Madrid Protocol	01/24/2018	1338246
NTDF	International Registration designating: China European Community Japan Korea	12/21/2016	1338246
NTDF	Taiwan	04/01/2018	1904636
NTDF	United Kingdom	04/06/2017	UK00801338246
NTDF	United States	01/16/2018	5377792
NTMF	China Madrid Protocol	04/23/2018	1338247
NTMF	European Community Madrid Protocol	04/06/2017	1338247
NTMF	Japan Madrid Protocol	07/20/2017	1338247
NTMF	Korea Madrid Protocol	01/24/2018	1338247
NTMF	International Registration designating: China European Community Japan Korea	12/21/2016	1338247
NTMF	Taiwan	04/01/2018	1904638
NTMF	United Kingdom	04/06/2017	UK00801338247
NTSCF	China Madrid Protocol	07/09/2018	1338042

NTSCF	European Community Madrid Protocol	04/06/2017	1338042
NTSCF	Japan Madrid Protocol	07/27/2017	1338042
NTSCF	Korea Madrid Protocol	02/27/2018	1338042
NTSCF	International Registration designating: China European Community Japan Korea	12/21/2016	1338042
NTSCF	Taiwan	04/01/2018	1904637
NTSCF	United Kingdom	04/06/2017	UK00801338042
NTSL	China Madrid Protocol	06/26/2018	1338248
NTSL	European Community Madrid Protocol	04/06/2017	1338248
NTSL	Japan Madrid Protocol	07/20/2017	1338248
NTSL	Korea Madrid Protocol	01/24/2018	1338248
NTSL	International Registration designating: China European Community Japan Korea	12/21/2016	1338248
NTSL	Taiwan	04/01/2018	1904639
NTSL	United Kingdom	04/06/2017	UK00801338248
NTSL	United States	01/16/2018	5377794

Mark	Country	Filing Date	Application No.
NANTERO	China Madrid Protocol	12/14/2016	1335136
NTMF	United States	12/14/2016	87/268912
NTSCF	United States	12/14/2016	87/268901
ULTIMALOGIC	United States	04/21/2018	87/887439